**WS:**  
  
Number of layers: **4**  
Dimensions: **77.3x127.47mm**  
Material type: **FR4Tg130**  
Finish plating: **ENIG**  
Inner copper Wt: **1 oz**  
Gold finger: **no**  
Thickness: **1.75mm**  
Array: **yes**  
Array Dim: **235x441mm**  
No. of boards/array: **12**  
X-out not allowed:   
X-out Qty:   
Outer copper Wt. **1.5 oz**  
Board Spec:   
Min. Trace/Space: **0.2/0.1mm**  
  
ITAR:   
Counterbore:   
Countersink:   
Soldermask: **Top/Bottom green**  
RoHS: **yes**  
Peelable Mask: **No**  
Plated Slots:**No**  
Controlled dielectric:   
Controlled impedance: **Yes, 10%**